EAST Search History

EAST Search History (Prior Art)

Ref#	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1	"10598514"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:21
\$2	842169	package	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:23
S3	1820343	chip die	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:23
S4	159802	S3 near5 (first second)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:25
S 5	45456	S2 and S4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:25
S 6	32444	S5 and (substrate PCB PWB)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:26
S 7	18025	S6 and ((substrate pcb pwb) near5 (first second))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:27

S 8	10270	S7 and (adhesive or (die near attach))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:28
S 9	3818	S8 and ((adhesive or (die near attach)) near5 (first second))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:29
S10	1900	S9 and (stack\$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:29
S11	371	S10 and ((substrate PCB PWB) near5 (open\$3 window))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:31
S12	189	S11 and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:33
S13	35	S12 and (substrate with conductive with trace)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 13:55
S14	8	S12 and (interpos\$3 with trace)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:22
S15	8	S12 and ((interpos\$3 redistribut\$3) with trace)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:44
S16	1748	((interpos\$3 redistribut\$3) with trace) and package	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:48

S17	70	S10 and S16	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:48
S18	31	S17 and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:48
S19	293	(interpos\$3 with redistribut \$3) and package	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:56
\$20	33	S10 and S19	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:57
S21	12	S20 and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 14:57
S22	73	Package and (redistribution with trace) and (stack\$2 with (die chip)) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 15:08
\$23	369	Package and (redistribution with trace) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 15:26
S24	296	S23 not S22	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 15:26
S 25	24	("20020005577" "20020172024" "5291061" "5323060" "5952725" "5998860" "6091140" "6118176" "6258626" "6343019" "6531784" "6650009").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/04 15:38

\$26	2	("20050239234").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/03/05 14:30
\$27	369	Package and (redistribution with trace) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 14:36
S28	104	11/030998 11/094623 11/181748 10/555054 10/559943 10/565624 11/341464 11/341673 11/276684 11/394263 10/576273 11/430844 11/479373 10/585733 10/585744 11/485334 11/486244 11/487234 10/586543 11/493583 11/494484 11/495653 11/463443 11/466773 11/513258 11/519754 10/598934 11/521553 11/524244 11/526464 11/526484 10/599609 11/588483 11/556448 11/593408 11/579944 11/593408 11/579944 11/598374 11/603224 11/603804 11/597613 11/604694 11/564588 11/607583 11/566274 11/607874 11/633493 11/608054 11/635874 11/611493 11/611664 11/640154 11/612213 11/643404 11/643144 11/615923 11/64883 11/646718 11/646248 11/646948 11/618453 11/61593 11/61853 11/618593 11/618974 11/632594 11/625474	US-PGPUB	OR	ON	2009/03/05 14:59

	11/782503 11/578304 PCT/ US07/23179 11/629703 11/236884 11/793184 12/128161 12/129652 12/202171				
\$29 100	(11/030998 11/094623 11/181748 10/555054 10/559943 10/565624 11/341464 11/341673 11/276684 11/394263 10/576273 11/430844 11/479373 10/585733 10/585744 11/485334 11/486244 11/487234 10/586543 11/493583 11/494484 11/495653 11/502094 11/466773 11/513258 11/519754 10/598934 11/521553 11/524244 11/526464 11/526484 10/599609 11/588483 11/579944 11/593408 11/579944 11/598374 11/603224 11/603804 11/597613 11/607583 11/566274 11/607874 11/633493 11/608054 11/635874 11/611493 11/611664 11/640154 11/612213 11/643404 11/643144 11/615923 11/644883 11/646718 11/646248 11/646948 11/618453 11/6467347 11/625474 11/632594 11/625474 11/632594 11/625474 11/632594 11/625474 11/675378 11/688338 11/785024 11/787144 10/581263 11/787554 11/789503 11/787554 11/789503 11/790854 11/789703 11/798563 11/798703 11/798704 10/580324 11/76584 11/779424 11/780253 11/798703 11/798704 10/580324 11/76584 11/779424 11/780253 11/798703 11/798704 10/580324 11/798704	US-PGPUB	OR	ON	2009/03/05

\$30	2	(11/030998 11/094623 11/181748 10/555054 10/559943 10/565624 11/341464 11/341673 11/276684 11/394263 10/576273 11/430844 11/479373 10/585733 10/585744 11/485334 11/486244 11/497234 10/586543 11/493583 11/494484 11/495653 11/463443 11/466773 11/513258 11/519754 10/598934 11/521553 11/524244 11/526464 11/526484 10/599609 11/588483 11/556448 11/593408 11/579944 11/598374 11/603224 11/603804 11/597613 11/604694 11/564588 11/607583 11/566274 11/607874 11/633493 11/608054 11/635874 11/611493 11/611664 11/640154 11/64213 11/646718 11/64883 11/646718 11/64883 11/646948 11/618453 11/618593 11/618974 11/632594 11/625474 11/632594 11/625474 11/657347 11/627219	US-PGPUB	OR	N	2009/03/05
S31	294	10/598514 11/659158 11/675378 11/688338 11/785024 11/787144 10/581263 11/787554 11/789503 11/790854 11/744384 11/800914 11/801023 11/801443 11/801823 11/798563 11/798703 11/798704 10/580324 11/756163 11/579194 11/776584 11/779424 11/780253 11/782503 11/578304 PCT/ US07/23179 11/629703 11/236884 11/793184 12/128161 12/129652 12/202171).crtx.	US-PGPUB;	OR	Z	2009/03/05
		\$3) and package	USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB			18:47

S32	169	S31 and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:47
S33	7	(interpos\$3 with redistribut \$3 with metal) and package and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:50
S34	40	(interpos\$3 same redistribut \$3 same metal) and package and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:53
S35	33	S34 not S33	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:54
S36	0	((interpos\$3 near2 metal) with redistributon) and package and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:57
S 37	0	((interpos\$3 near5 metal) with redistributon) and package and (@ad< "20040303" or @pd< "20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:57
S38	0	((interpos\$3 near2 metal) same redistributon) and package and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:57
S39	654	(interpos\$3 near2 metal) and package and (@ad< "20040303" or @pd< "20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:58
\$40	49	(interpos\$3 near2 metal) and package and (stack\$2 near4 (die chip)) and (@ad< "20040303" or @pd< "20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/05 18:59

S41	2893	257/678.ccls. and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/06 11:52
S42	499	S41 and (stack\$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/03/06 11:52
S43	23607	"20030701"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/03/06 12:11
S44	2	"10611390"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/03/06 12:11
S45	2	"6952047".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/03/06 12:12
S46	2	"20040108581"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/03/06 12:14
S47	4	10/611390	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/12 22:38
S48	2	("20040018661").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/12 22:50
S 49	2	"5422435".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/12 22:51

S50	3	"20050104209"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/12 23:10
S51	2	("20050104209").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/12 23:10
S52	888683	package	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S53	1915120	chip die	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S54	168270	S53 near5 (first second)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S55	48831	S52 and S54	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S56	35032	S55 and (substrate PCB PWB)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S57	19549	S56 and ((substrate pcb pwb) near5 (first second))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S58	11089	S57 and (adhesive or (die near attach))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38

S59	4140	S58 and ((adhesive or (die near attach)) near5 (first second))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S60	2090	S59 and (stack\$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S61	413	S60 and ((substrate PCB PWB) near5 (open\$3 window))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S62	189	S61 and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S63	35	S62 and (substrate with conductive with trace)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S64	28	S63 and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/12 23:38
S65	24	("20020005577" "20020172024" "5291061" "5323060" "5952725" "5998860" "6091140" "6118176" "6258626" "6343019" "6531784" "6650009").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/13 00:12
S66	85	(redistribution near3 (wafer chip)) and (stack\$2 with (die chip)) and (@ad< "20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 00:26
S67	0	S66 and (metal\$3 near3 interposer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 00:42

S68	58	(metal\$3 near3 interposer) and (stack\$2 with (die chip)) and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 00:43
S69	35	(metal\$3 near2 interposer) and (stack\$2 with (die chip)) and (@ad< "20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:07
S70	9	Package and (metal\$3 adj interposer) and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:17
S71	18	(metal\$3 with interposer with trace with pad) and (@ad< "20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:21
S72	24	("20020005577" "20020172024" "5291061" "5323060" "5952725" "5998860" "6091140" "6118176" "6258626" "6343019" "6531784" "6650009").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:37
S73	2	10/206720	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:41
S74	100	((encapsula\$4 or mold) with liquid with transfer).clm. and (@ad< "20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 01:57
S75	2	("20030197284").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/13 02:03
S76	0	((encapsula\$4 or mold) with liquid with transfer with lid). clm. and (@ad< "20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 02:11

S77	1	((encapsula\$4 or mold) with liquid with transfer with cover).clm. and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 02:11
S78	29	(((encapsula\$4 or mold) near2 liquid) and ((encapsula \$4 or mold) near2 transfer)). clm. and (@ad<"20040303")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 02:16
S79	0	((interpos\$3 adj metal) with adhesive).clm. and @ad<"20040303"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 02:54
S80	5	((interpos\$3 adj metal) and adhesive).clm. and @ad<"20040303"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2009/10/13 02:54
S81	2	("20040178482").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/13 09:10
S82	2	("20040124539").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/10/13 09:12
S83	61	((underfill near4 adhesive) with polymer) and (@ad<"20040303" or @pd<"20060129")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/04/29 19:16

5/12/2010 3:57:28 PM

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